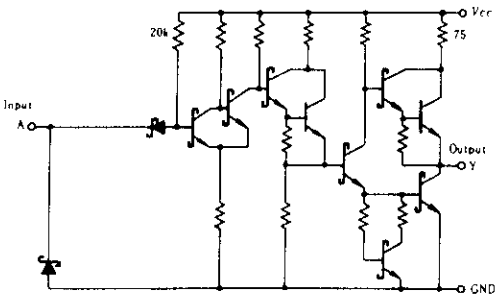
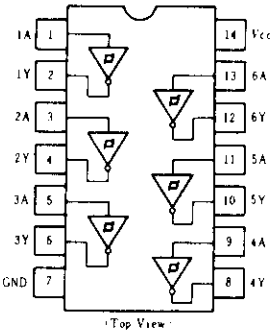
HD74LS14 ●Hex Schmitt Trigger Inverters

■CIRCUIT SCHEMATIC(1/6)



■PIN ARRANGEMENT



■ELECTRICAL CHARACTERISTICS ($Ta=-20\sim+75°C$)

Item	Symbol	Test Conditions	min	typ*	max	Unit
Input threshold voltage	V_{T^+}	$V_{CC}=5V$	1.4	1.6	1.9	V
	V_{T^-}	$V_{CC}=5V$	0.5	0.7	1.0	V
Hysteresis	$V_{T^+}-V_{T^-}$	$V_{CC}=5V$	0.4	0.9	—	V
Output voltage	V_{OH}	$V_{CC}=4.75V$, $V_I=0.5V$, $I_{OH}=-400\mu A$	2.7	—	—	V
	V_{OL}	$V_{CC}=4.75V$, $V_I=1.9V$, $I_{OL}=8mA$	—	—	0.50	V
		$V_{CC}=4.75V$, $V_I=1.9V$, $I_{OL}=4mA$	—	—	0.40	
Input threshold current	I_{T^+}	$V_{CC}=5V$, $V_I=V_{T^+}$	—	−0.14	—	mA
	I_{T^-}	$V_{CC}=5V$, $V_I=V_{T^-}$	—	−0.18	—	mA
Input current	I_{IH}	$V_{CC}=5.25V$, $V_I=2.7V$	—	—	20	μA
	I_{IL}	$V_{CC}=5.25V$, $V_I=0.4V$	—	—	−0.4	mA
	I_I	$V_{CC}=5.25V$, $V_I=7V$	—	—	0.1	mA
Short-circuit output current	I_{OS}	$V_{CC}=5.25V$	−20	—	−100	mA
Supply current	I_{CCH}	$V_{CC}=5.25V$	—	8.6	16	mA
	I_{CCL}	$V_{CC}=5.25V$	—	12	21	mA
Input clamp voltage	V_{IK}	$V_{CC}=4.75V$, $I_{IN}=-18mA$	—	—	−1.5	V

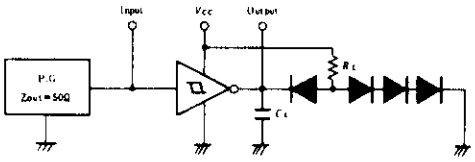
* V_{CC}=5V, Ta=25°C

■SWITCHING CHARACTERISTICS ($V_{CC}=5V$, $Ta=25°C$)

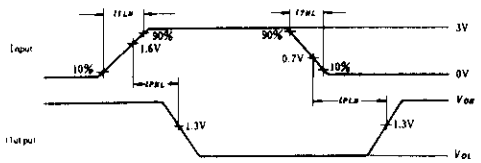
Item	Symbol	Test Conditions	min	typ	max	Unit
Propagation delay time	t_{PLH}	$C_L=15pF$, $R_L=2k\Omega$	—	15	22	ns
	t_{PHL}		—	15	22	ns

■TESTING METHOD

1. Test Circuit

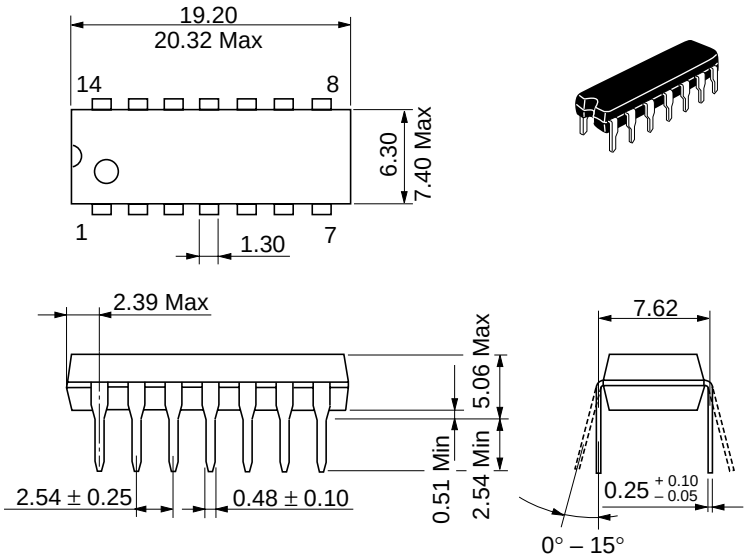


Waveform



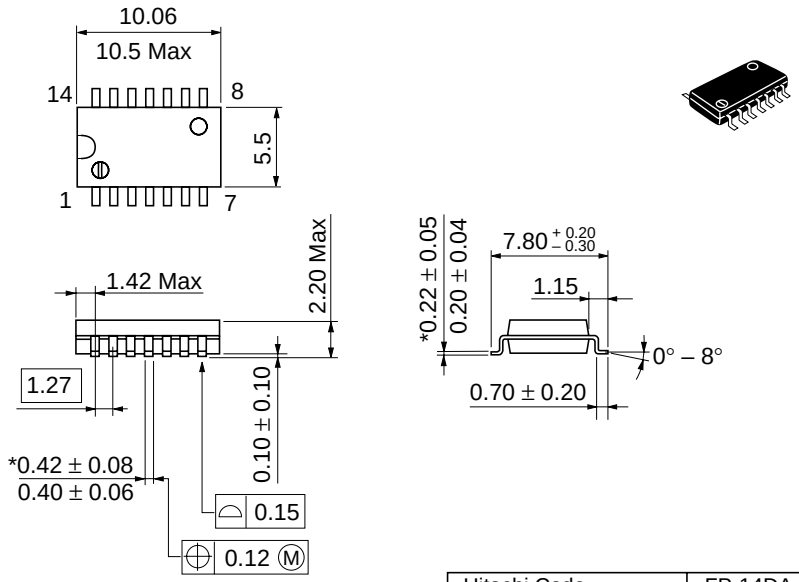
Notes) 1. Input pulse; $t_{TLH}\leqq15ns$, $t_{THL}\leqq6ns$, PRR=1MHz, duty cycle=50%
2. C_L includes probe and jig capacitance.
3. All diodes are 1S2074 Ⓗ.

Unit: mm



Hitachi Code	DP-14
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.97 g

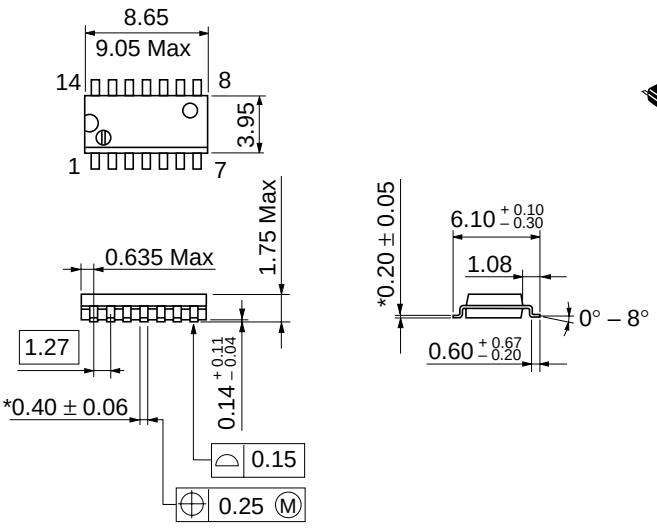
Unit: mm



Hitachi Code	FP-14DA
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.23 g

*Dimension including the plating thickness
Base material dimension

Unit: mm



Hitachi Code	FP-14DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.13 g

*Pd plating

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